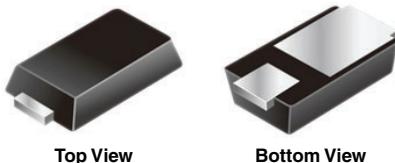


Surface Mount Schottky Barrier Rectifiers

eSMP® Series



Top View

Bottom View

MicroSMP (DO-219AD)

FEATURES

- Very low profile - typical height of 0.65 mm
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: MicroSMP

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified
("X" denotes revision code e.g. A, B,...)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.0 A
V_{RRM}	50 V, 60 V
I_{FSM}	25 A
V_F at $I_F = 1.0$ A	0.52 V
T_J max.	150 °C
Package	MicroSMP
Diode variations	Single

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)				
PARAMETER	SYMBOL	MSS1P5	MSS1P6	UNIT
Device marking code		15	16	
Maximum repetitive peak reverse voltage	V_{RRM}	50	60	V
Maximum average forward rectified current (fig. 1)	$I_{F(AV)}$	1.0		A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	25		A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150		°C

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Maximum instantaneous forward voltage	$I_F = 0.5 \text{ A}$	$T_J = 25^\circ\text{C}$	V_F ⁽¹⁾	0.45	-	V	
	$I_F = 1.0 \text{ A}$			0.56	0.68		
	$I_F = 0.5 \text{ A}$	$T_J = 125^\circ\text{C}$		0.40	-		
	$I_F = 1.0 \text{ A}$			0.52	0.60		
Maximum reverse current	Rated V_R	$T_J = 25^\circ\text{C}$	I_R ⁽²⁾	20	150	μA	
		$T_J = 125^\circ\text{C}$		7.0	12	mA	
Typical junction capacitance	4.0 V, 1 MHz		C_J	40	-	pF	

Notes

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width $\leq 40 \text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	SYMBOL	MSS1P5	MSS1P6	UNIT			
Typical thermal resistance	$R_{\theta JA}$ ⁽¹⁾	125		°C/W			
	$R_{\theta JL}$ ⁽¹⁾	30					
	$R_{\theta JC}$ ⁽¹⁾	40					

Note

(1) Thermal resistance from junction to ambient and junction to lead mounted on PCB with 6.0 mm x 6.0 mm copper pad areas $R_{\theta JL}$ is measured at the terminal of cathode band. $R_{\theta JC}$ is measured at the top center of the body

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
MSS1P6-M3/89A	0.006	89A	4500	7" diameter plastic tape and reel
MSS1P6HM3_A/H ⁽¹⁾	0.006	H	4500	7" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified

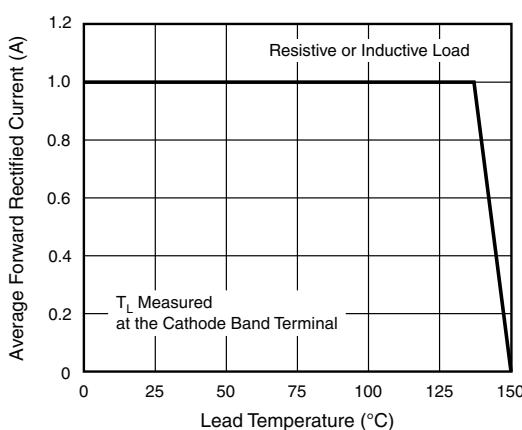
RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

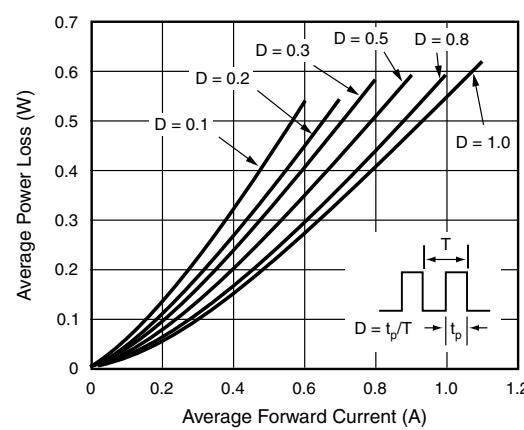


Fig. 2 - Forward Power Loss Characteristics

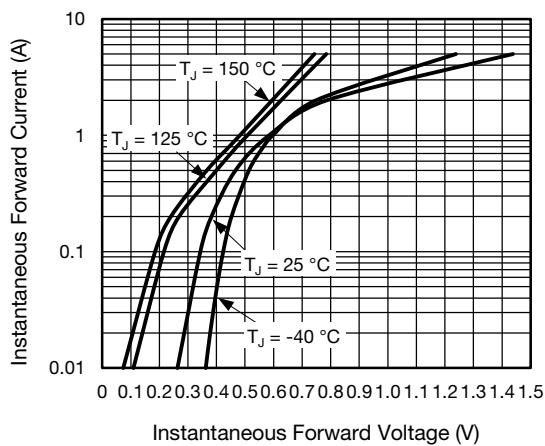


Fig. 3 - Typical Instantaneous Forward Characteristics

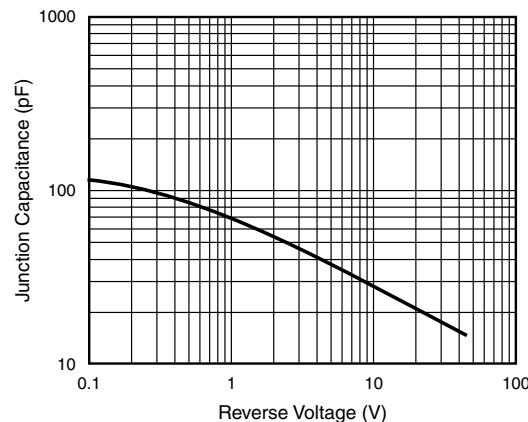


Fig. 5 - Typical Junction Capacitance

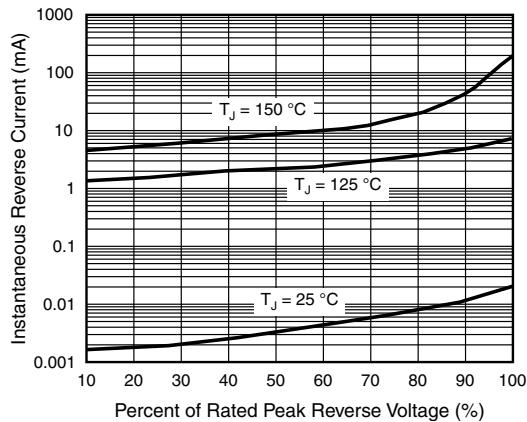


Fig. 4 - Typical Reverse Characteristics

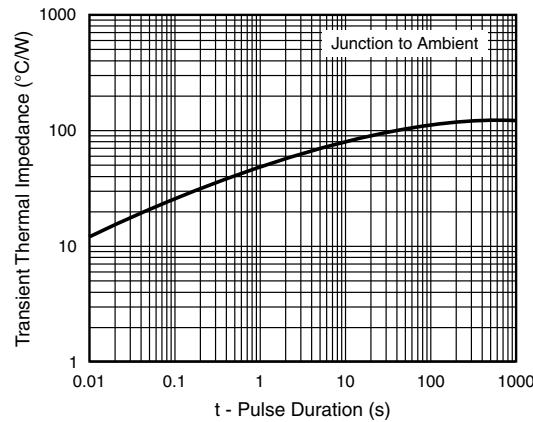
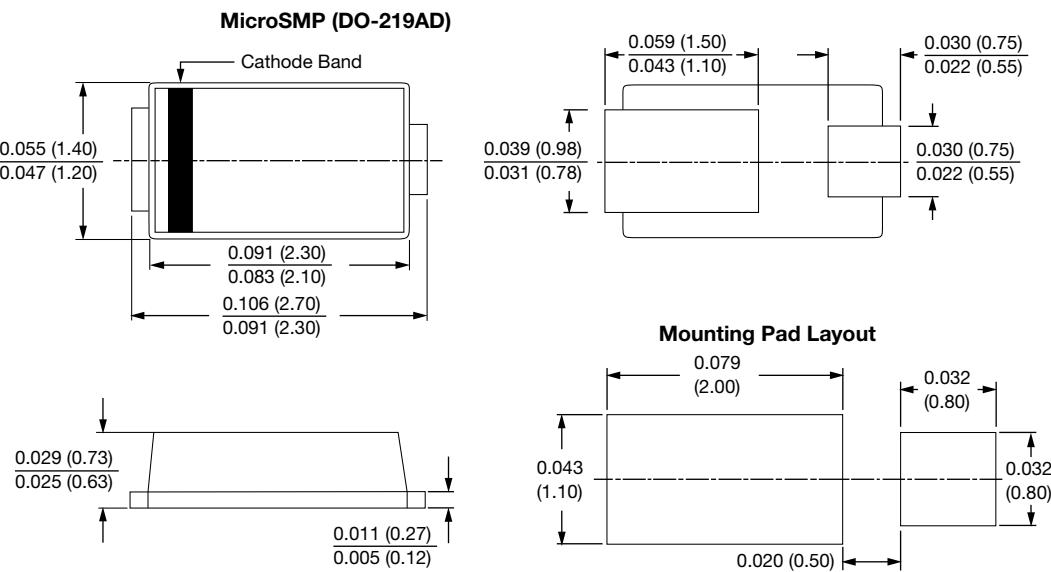


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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